



LET9002

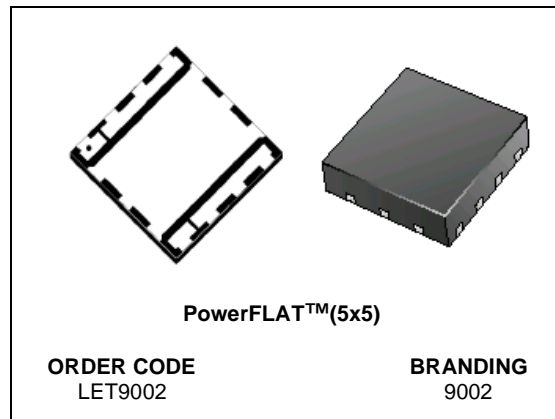
RF POWER TRANSISTORS

Ldmos Enhanced Technology in Plastic Package

TARGET DATA

N-CHANNEL ENHANCEMENT-MODE LATERAL MOSFETs

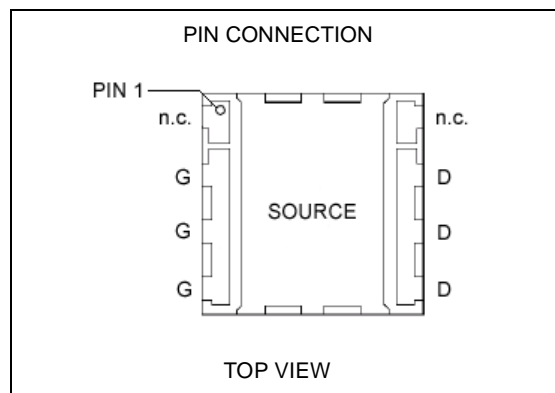
- EXCELLENT THERMAL STABILITY
- COMMON SOURCE CONFIGURATION
- $P_{OUT} = 2\text{ W}$ with 17 dB gain @ 960 MHz / 26 V
- NEW LEADLESS PLASTIC PACKAGE
- ESD PROTECTION
- SUPPLIED IN TAPE & REEL OF 3K UNITS



DESCRIPTION

The LET9002 is a common source N-Channel, enhancement-mode lateral Field-Effect RF power transistor designed for broadband commercial and industrial applications at frequencies up to 1000 MHz. The LET9002 is designed for high gain and broadband performance operating in common source mode at 26 V. LET9002 boasts the excellent gain, linearity and reliability of ST's latest LDMOS technology mounted in the innovative leadless SMD plastic package, PowerFLAT™.

It is ideal for digital cellular BTS applications requiring high linearity.



ABSOLUTE MAXIMUM RATINGS ($T_{CASE} = 25^{\circ}\text{C}$)

Symbol	Parameter	Value	Unit
$V_{(BR)DSS}$	Drain-Source Voltage	65	V
V_{GS}	Gate-Source Voltage	-0.5 to +15	V
I_D	Drain Current	0.25	A
P_{DISS}	Power Dissipation (@ $T_c = 70^{\circ}\text{C}$)	4	W
T_j	Max. Operating Junction Temperature	150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature	-65 to +150	$^{\circ}\text{C}$

THERMAL DATA

$R_{th(j-c)}$	Junction -Case Thermal Resistance	20	$^{\circ}\text{C/W}$
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ELECTRICAL SPECIFICATION ($T_{CASE} = 25^{\circ}C$)**STATIC**

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}$	$I_{DS} = 1\text{ mA}$	65			V
I_{DSS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 26\text{ V}$			1	μA
I_{GSS}	$V_{GS} = 5\text{ V}$	$V_{DS} = 0\text{ V}$			1	μA
$V_{GS(Q)}$	$V_{DS} = 26\text{ V}$	$I_D = \text{TBD}$	2.0		5.0	V
$V_{DS(ON)}$	$V_{GS} = 10\text{ V}$	$I_D = 125\text{ mA}$			0.9	V
g_{FS}	$V_{DS} = 10\text{ V}$	$I_D = 200\text{ mA}$		--		mho
C_{ISS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 26\text{ V}$		TBD		pF
C_{OSS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 26\text{ V}$		TBD		pF
C_{RSS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 26\text{ V}$		TBD		pF

DYNAMIC ($f = 960\text{ MHz}$)

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
$P_{out}^{(1)}$	$V_{DD} = 26\text{ V}$	$I_{DQ} = \text{TBD}$	2.5	3		W
$\eta_D^{(1)}$	$V_{DD} = 26\text{ V}$	$I_{DQ} = \text{TBD}$ $P_{OUT} = 2\text{ W}$	55	65		%
Load mismatch	$V_{DD} = 26\text{ V}$ $I_{DQ} = \text{TBD}$ $P_{OUT} = 2\text{ W}$ ALL PHASE ANGLES				10:1	VSWR

(1) 1 dB Compression point

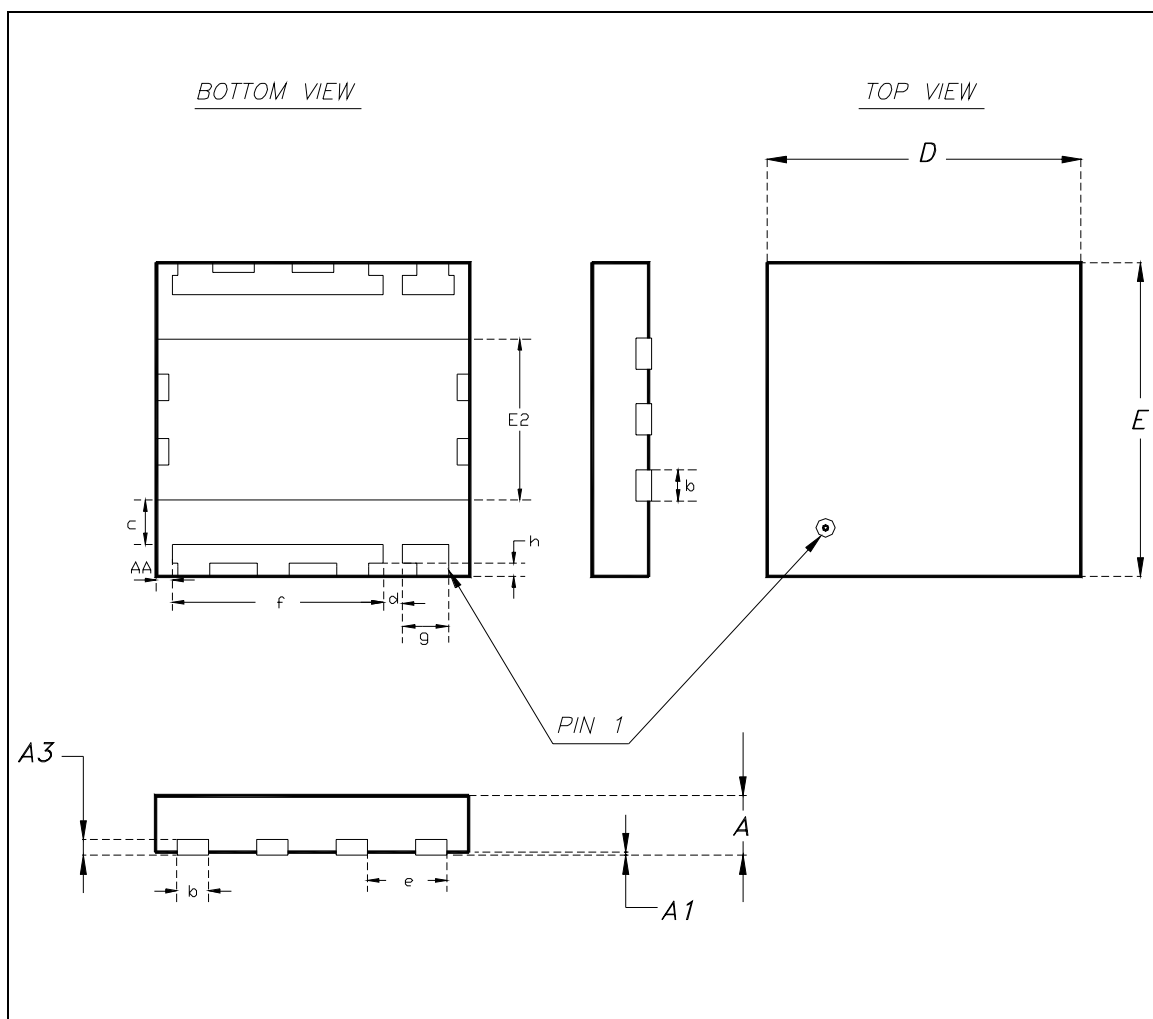
DYNAMIC ($f = 920 - 960\text{ MHz}$)

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
$P_{out}^{(1)}$	$V_{DD} = 26\text{ V}$	$I_{DQ} = \text{TBD}$	2	2.5		W
$\eta_D^{(1)}$	$V_{DD} = 26\text{ V}$	$I_{DQ} = \text{TBD}$	55	60		%
G_P	$V_{DD} = 26\text{ V}$	$I_{DQ} = \text{TBD}$ $P_{OUT} = 2\text{ W}$	17			dB

(1) 1 dB Compression point

PowerFLAT™ MECHANICAL DATA

DIM.	mm			Inch		
	MIN.	TYP.	MAX	MIN.	TYP.	MAX
A		0.90	1.00		0.035	0.039
A1		0.02	0.05		0.001	0.002
A3		0.24			0.009	
AA	0.15	0.25	0.35	0.006	0.01	0.014
b	0.43	0.51	0.58	0.017	0.020	0.023
c	0.64	0.71	0.79	0.025	0.028	0.031
D		5.00			0.197	
d		0.30			0.011	
E		5.00			0.197	
E2	2.49	2.57	2.64	0.098	0.101	0.104
e		1.27			0.050	
f		3.37			0.132	
g		0.74			0.03	
h		0.21			0.008	



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